

TOSHIBA TRANSISTOR SILICON NPN EPITAXIAL PLANAR TYPE

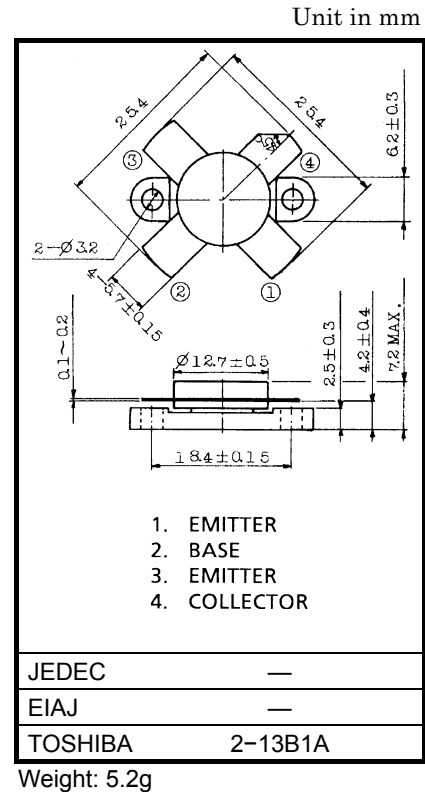
## 2SC2510A

2~30MHz SSB LINEAR POWER AMPLIFIER APPLICATIONS  
(28V SUPPLY VOLTAGE USE)

- Specified 28V, 28MHz Characteristics
- Output Power :  $P_o = 150W_{PEP}$  (Min.)
- Power Gain :  $G_p = 12.2dB$  (Min.)
- Collector Efficiency :  $\eta_C = 35\%$  (Min.)
- Intermodulation Distortion:  $IMD = -30dB$  (Max.)

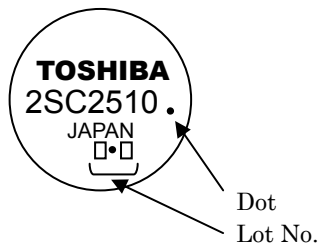
### ABSOLUTE MAXIMUM RATINGS ( $T_c = 25^\circ C$ )

CHARACTERISTIC	SYMBOL	RATING	UNIT
Collector-Base Voltage	$V_{CBO}$	60	V
Collector-Emitter Voltage	$V_{CES}$	60	V
Collector-Emitter Voltage	$V_{CEO}$	35	V
Emitter-Base Voltage	$V_{EBO}$	4	V
Collector Current	$I_C$	20	A
Collector Power Dissipation	$P_C$	250	W
Junction Temperature	$T_j$	175	$^\circ C$
Storage Temperature Range	$T_{stg}$	-65~175	$^\circ C$



Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

### MARKING

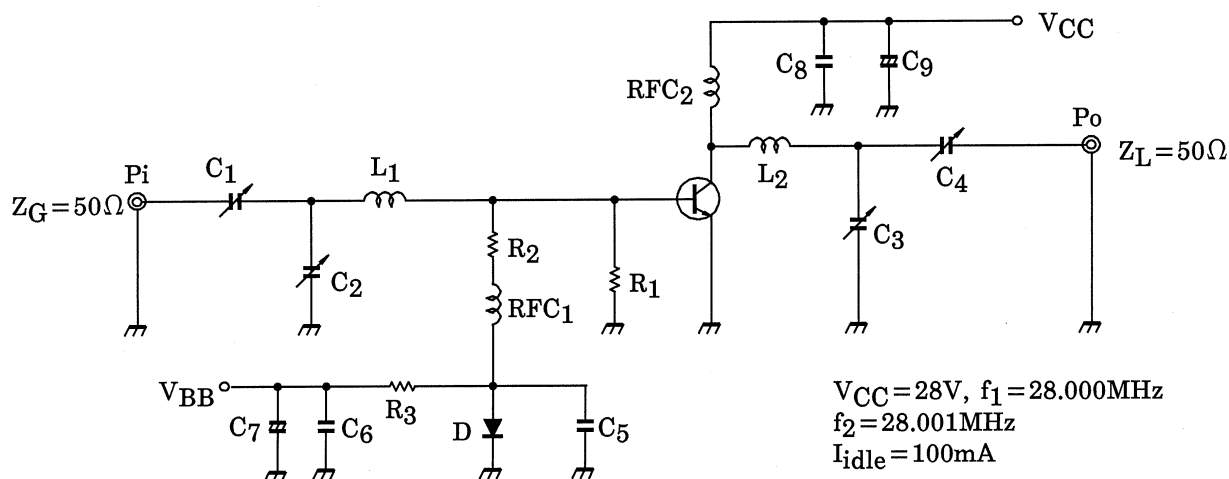


ELECTRICAL CHARACTERISTICS ( $T_c = 25^\circ\text{C}$ )

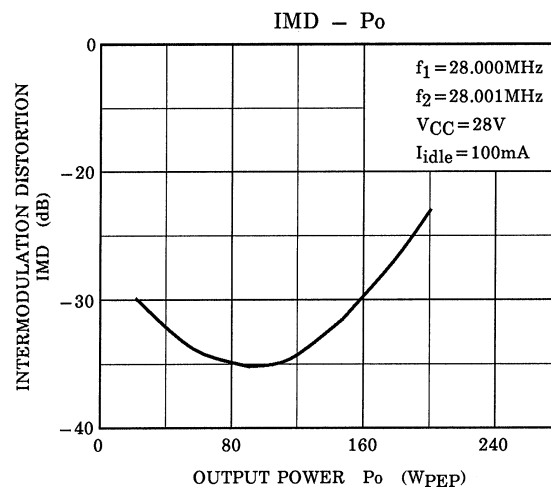
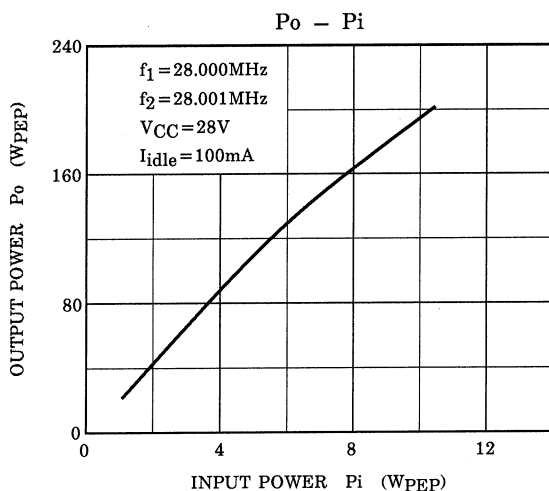
CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Collector-Emitter Breakdown Voltage	$V_{(BR) CEO}$	$I_C = 100\text{mA}$ , $I_B = 0$	35	—	—	V
Collector-Emitter Breakdown Voltage	$V_{(BR) CES}$	$I_C = 100\text{mA}$ , $V_{EB} = 0$	55	—	—	V
Emitter-Base Breakdown Voltage	$V_{(BR) EBO}$	$I_E = 1\text{mA}$ , $I_C = 0$	4	—	—	V
DC Current Gain	$h_{FE}$	$V_{CE} = 5\text{V}$ , $I_C = 10\text{A}^*$	10	—	—	
Collector Output Capacitance	$C_{ob}$	$V_{CB} = 28\text{V}$ , $I_E = 0$ $f = 1\text{MHz}$	—	450	600	pF
Power Gain	$G_p$	$V_{CC} = 28\text{V}$ , $f_1 = 28.000\text{MHz}$ , $f_2 = 28.001\text{MHz}$ $I_{idle} = 100\text{mA}$ $P_o = 150W_{PEP}$ (Fig.)	12.2	13.3	—	dB
Input Power	$P_i$		—	7	9	$W_{PEP}$
Collector Efficiency	$\eta_C$		35	—	—	%
Intermodulation Distortion	IMD		—	—	-30	dB
Series Equivalent Input Impedance	$Z_{in}$	$V_{CC} = 28\text{V}$ , $f_1 = 28.000\text{MHz}$ , $f_2 = 28.001\text{MHz}$ , $P_o = 150W_{PEP}$	—	1.4 -j0.9	—	$\Omega$
Series Equivalent Output Impedance	$Z_{out}$		—	2.3 -j0.9	—	$\Omega$

\* Pulse Test: Pulse Width  $\leq 100\mu\text{s}$ , Duty Cycle  $\leq 3\%$

Fig. Pi TEST CIRCUIT



$C_1, C_2$	: 7~150pF	$L_1$	: $\phi 0.8$ ENAMEL COATED COPPER WIRE, 14ID, 4T, 4P
$C_3, C_4$	: 7~150pF 2KWV	$L_2$	: $\phi 1.2$ ENAMEL COATED COPPER WIRE, 14ID, 3 1/2T, 3P
$C_5, C_6$	: 0.022 $\mu$ F	$RFC_1$	: $\phi 0.8$ ENAMEL COATED COPPER WIRE, 10ID, 9T (Ferrite Core TDK K2)
$C_7$	: 47 $\mu$ F 10WV	$RFC_2$	: $\phi 0.8$ ENAMEL COATED COPPER WIRE, 14ID, 20T
$C_8$	: 0.04 $\mu$ F	$R_1$	: 10 $\Omega$ (1W)
$C_9$	: 100 $\mu$ F 50WV	$R_2$	: 2 $\Omega$ (1/2W)
		$R_3$	: 10 $\Omega$ (5W)
		D	: 1S1555



## CAUTION

These are only typical curves and devices are not necessarily guaranteed at these curves.

**RESTRICTIONS ON PRODUCT USE**

20070701-EN GENERAL

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